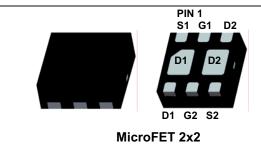
FAIRCHILD

FDMA1028NZ Dual N-Channel PowerTrench[®] MOSFET

General Description

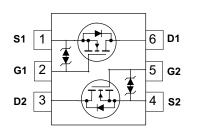
This device is designed specifically as a single package solution for dual switching requirements in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses. The MicroFET 2x2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



Features

■ 3.7 A, 20V. $R_{DS(ON)} = 68 \text{ m}\Omega @ V_{GS} = 4.5V$ $R_{DS(ON)} = 86 \text{ m}\Omega @ V_{GS} = 2.5V$

- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- HBM ESD protection level > 2kV (Note 3)
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain-Source Voltage		20	V
V _{GS}	Gate-Source Voltage		±12	V
1	Drain Current – Continuous	(Note 1a)	3.7	A
ID	– Pulsed		6	
PD	Power Dissipation for Single Operation	(Note 1a)	1.4	W
		(Note 1b)	0.7	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	86 (Single Operation)		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	173 (Single Operation)	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1c)	69 (Dual Operation)		
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1d)	151 (Dual Operation)		

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
028	FDMA1028NZ	7"	8mm	3000 units

©20F€ Fairchild Semiconductor Corporation

FDMA1028NZ Rev BI

May 20%\$

Electrical Characteristics T _A = 25°C unless otherwise noted						l l
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	·			•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		15		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 12 V$, $V_{DS} = 0 V$			±10	μA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, I_D = 3.7 \ A \\ V_{GS} = 2.5 \ V, I_D = 3.3 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 3.7 \ A, \ T_J = 125^{\circ} C \end{array} $		37 50 53	68 86 90	mΩ
g _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 3.7 A		16		S
Dynamic	Characteristics	•				
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		340		pF
Coss	Output Capacitance	f = 1.0 MHz		80		pF
C _{rss}	Reverse Transfer Capacitance	1		60		pF
Switchin	q Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V, I_D = 1 A,$		8	16	ns
t _r	Turn–On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 6 Ω		8	16	ns
t _{d(off)}	Turn–Off Delay Time	1		14	26	ns
t _f	Turn–Off Fall Time	1		3	6	ns
Q _g	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_D = 3.7 \text{ A},$		4	6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 4.5 V		0.7		nC
Q _{gd}	Gate-Drain Charge	1		1.1		nC

FDMA1028NZ Dual N-Channel PowerTrench[®] MOSFET

FDMA1028NZ Rev BI

Notes:

R_{0JA} is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.
(a) R_{0JA} = 86 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.

(b) $R_{\theta JA}$ = 173 °C/W when mounted on a minimum pad of 2 oz copper. For single operation.

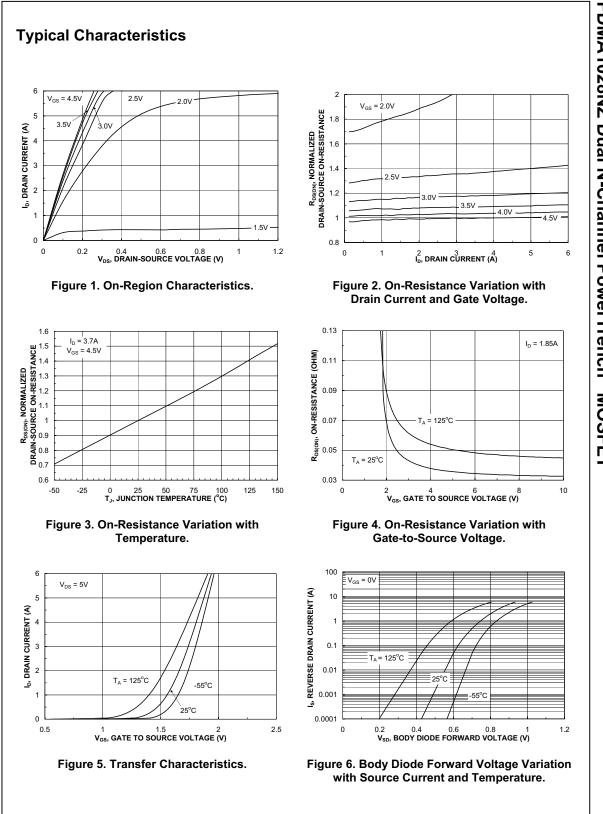
(c) $R_{\theta JA}$ = 69 °C/W when mounted on a 1 in² pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation.

(d) R_{0JA} = 151 °C/W when mounted on a minimum pad of 2 oz copper. For dual operation.



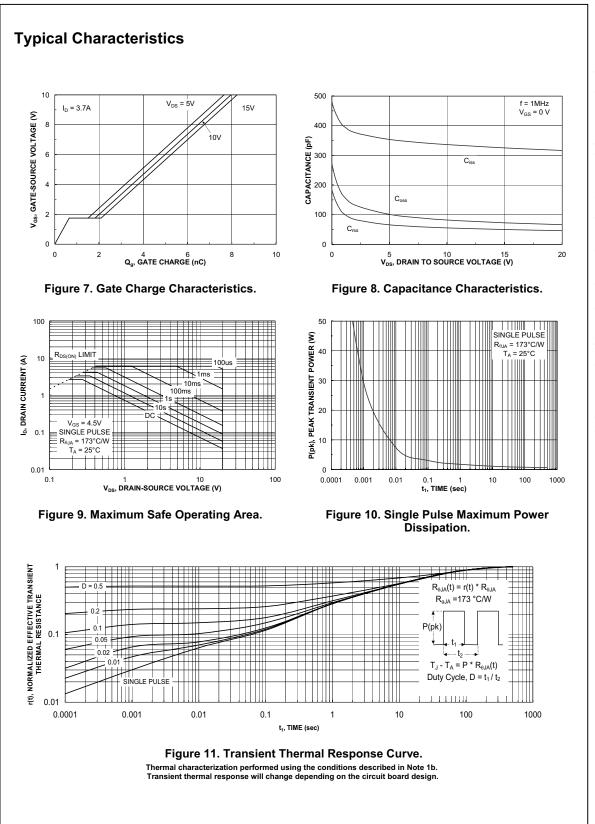
2. Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



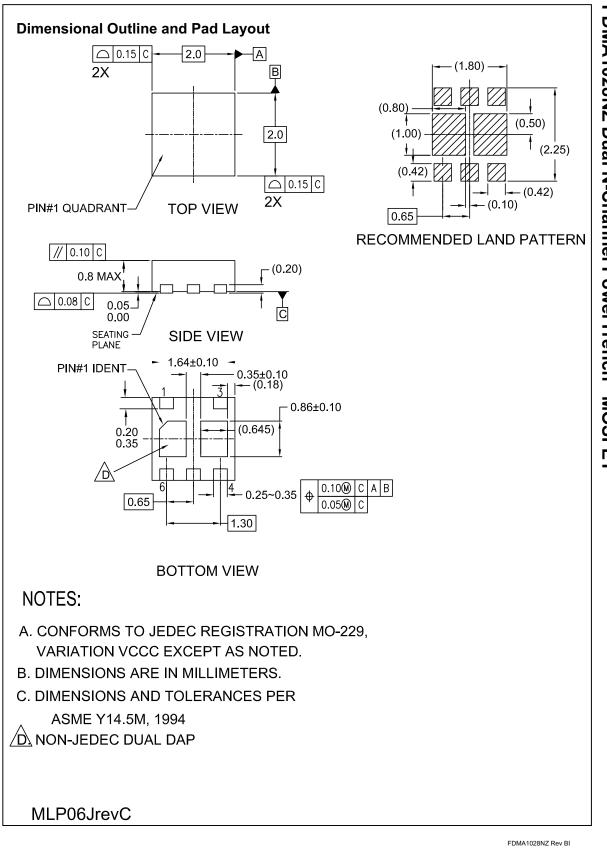
FDMA1028NZ Dual N-Channel PowerTrench[®] MOSFET

FDMA1028NZ Rev BI

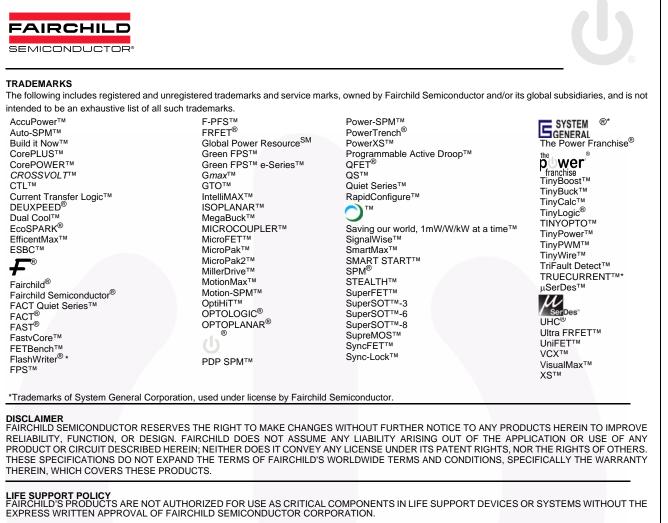


FDMA1028NZ Dual N-Channel PowerTrench[®] MOSFET

FDMA1028NZ Rev BI



FDMA1028NZ Dual N-Channel PowerTrench[®] MOSFET



As used here in:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specificat may change in any manner without notice.		
Preliminary First Production		Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed Full Production Datasheet make char		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete Not In Production		Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 148